

Product/process change notification

PCN N° 2021-119-A

Dear customer,

Please find attached our Infineon Technologies AG PCN:

Introduction of an additional assembly production and test site at Hana Semiconductor (Ayutthaya, Thailand) Co., Ltd. for products 1ED44176N01F and 2ED28073J06F. Introduction of a new leadframe and mold compound for products IRS2302SPBF and IRS2302STRPBF with no change of assembly production and test sites

Important information for your attention:

- Please respond to this PCN by indicating your decision on the approval form, sign it and return to your sales partner before 2022-12-16
- Infineon aligns with the widely recognized JEDEC STANDARD "JESD46", which stipulates: "Lack of acknowledgement of the PCN within 30 days constitutes acceptance of the change."

Your prompt reply will help Infineon to assure a smooth and well-executed transition. If Infineon does not hear from your side by the due date, we will assume your full acceptance to this proposed change and its implementation.

Your attention and response to this matter is greatly appreciated.



On 16 April 2020, Infineon acquired Cypress. We are now in the process of merging and consolidating our tools and processes for PCN, Information Notes, Errata and Product Discontinuance. For further details, please visit our website: https://www.infineon.com/cms/en/about-infineon/company/cypress-acquisition/

Infineon Technologies AG

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Management Board Jochen Hanebeck (CEO), Constanze Hufenbecher, Dr. Sven Schneider, Andreas Urschitz, Dr. Rutger Wijburg Registered office Neubiberg Commercial register Amtsgericht München HRB 126492

restricted



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Products affected
Please refer to attached affected product list
"PCN_2021-119-A_[customer-no].pdf"

Detailed change information

Subject	Introduction of an additional assembly production and test site at Hana Semiconductor (Ayutthaya, Thailand) Co., Ltd. for products 1ED44176N01F and 2ED28073J06F. Introduction of a new leadframe and mold compound for products IRS2302SPBF and IRS2302STRPBF with no change of assembly production and test sites.				
Reason	Expansion of production capacity to ensure continuity of supply and enable flexible manufacturing as well as harmonizing material due to Hana Semiconductor's manufacturing strategy.				
Description	<u>Old</u>	New			
	<u>1ED44176N01F</u> ■ JCET Group (Suzhou- Suqian, Jiangsu) Co., Ltd.	 <u>1ED44176N01F</u> JCET Group (Suzhou- Suqian, Jiangsu) Co., Ltd 			
	 Carsem Sdn.Bhd.(Malaysia) 	 Carsem Sdn.Bhd.(Malaysia) 			
		 Hana Semiconductor (Ayutthaya, Thailand) Co., Ltd. 			
	 <u>2ED28073J06F</u> JCET Group (Suzhou- Suqian, Jiangsu) Co., Ltd 	 <u>2ED28073J06F</u> JCET Group (Suzhou- Suqian, Jiangsu) Co., Ltd 			
		 Hana Semiconductor (Ayutthaya, Thailand) Co., Ltd. 			
	 IRS2302SPBF and IRS2302STRPBF Leadframe: High Density Leadframe Wire: Au Mold compound: CEL9220HF 	 IRS2302SPBF and IRS2302STRPBF Leadframe: Ultra High Density Leadframe Wire: Cu Mold compound: CEL8240HF 			



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 Product identification 	Ensured by internal traceability in manufacturing execution systems.		
 Impact of change 	Based on the qualification performed, Infineon does not see any negative impact on quality, function or reliability. No change in fit, form and function.		
 Attachments 	PCN_2019-119-A_[customer-no].pdf affected product list		
► Time schedule			
 Final qualification report 	On request		
 First samples available 	On request		
Intended start of delivery	2022-11-30 or earlier on customer request.		

If you have any questions, please do not hesitate to contact your local sales office.

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Affected products sold to DIGI-KEY (4002348)

Sales name	SP number	OPN	Package	Customer part number
1ED44176N01F	SP001885916	1ED44176N01FXUMA 1	PG-DSO-8	1ED44176N01FXUMA1
2ED28073J06F	SP005347726	2ED28073J06FXUMA1	PG-DSO-8	2ED28073J06FXUMA1
IRS2302SPBF	SP001534890	IRS2302SPBF	SOIC 8N	IRS2302SPBF